

ADOPTION NOTICE

IPC-TM-650, Number 2.6.5, "Physical Shock, Multilayer Printed Wiring", was adopted on 22 March 2005, for use by the Department of Defense (DoD). Proposed changes by DoD activities shall be submitted to the DoD Adopting Activity: Defense Logistics Agency, Defense Supply Center, Columbus, ATTN: DSCC-VAC, P.O. Box 3990, Columbus, OH 43218-3990 or [5998.Documents@dla.mil](mailto:5998.Documents@dla.mil).

(Copies of IPC-TM-650, Number 2.6.5 are available online from <http://www.ipc.org> or may be purchased from the IPC - Association Connecting Electronics Industry, 3000 Lakeside Drive, Suite 309 S, Bannockburn, IL 60015-1249).

Custodians:

Army – CR  
Navy – EC  
Air Force – 11  
DLA – CC

Adopting Activity:  
DLA – CC

(Project 5998–0196–04)

Reviewer Activity:

Air Force – 71, 99  
NASA – NA

NOTE: The activities listed above were interested in this document as of the date of this document. Since organizations and responsibilities can change, you should verify the currency of the information above using the ASSIST Online database at <http://assist.daps.dla.mil>.